

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L2	63	(nonfunct\$5 adj (die chip ic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/01 17:41
L3	33	257/48.ccls. and (die wafer chip ic) with segment	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/01 17:50
L4	79	(nonfunct\$5 adj (die chip ic))	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/01 17:41
L5	92	257/723-724.ccls. and (die wafer chip ic) with segment	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/01 18:01
L6	6	(("6627917") or ("6486005") or ("6744067")).PN.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/01 17:55
L7	96	257/773,737-738.ccls. and (die wafer chip ic) with segment	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/01 18:28
L8	100	257/690,778.ccls. and (die wafer chip ic) with segment	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/01 18:35
L9	92	257/723-724.ccls. and (die wafer chip ic) with segment	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2006/02/01 19:33
L11	37	(wafer adj segment) with (chip die)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2006/02/01 19:35